

Board Level Cooling – Extruded 5338



BOARD LEVEL COOLING - EXTRUDED 5338

Extruded 5338 is a dual radial board level heat sink designed to cool TO-220 and TO-220-single gauge devices. Representative image only.



ORDERING INFORMATION

Part Number	Device Type
533802B02500G	TO-220, TO-220-single gauge (0.020")

HEAT SINK DETAILS

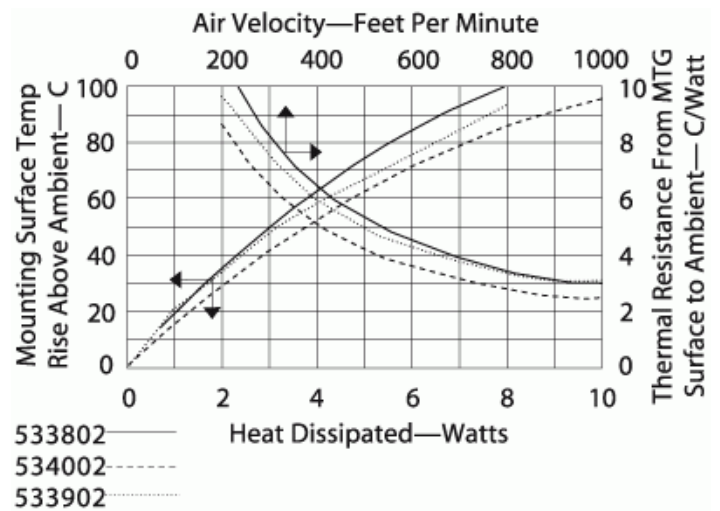
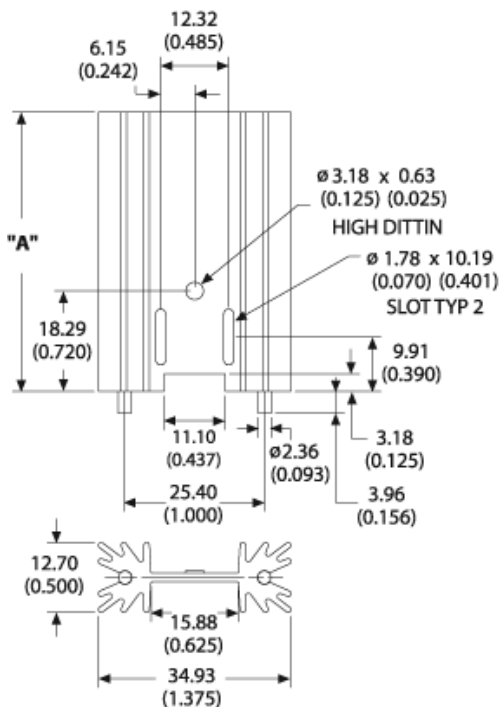
Property	Details
Material	Aluminum
Finish	Black Anodize
Device Attachment Options	Requires Mounting Clip
Thermal Interface Material	-

Property	Details
Heat Sink Width (mm)	34.93
Heat Sink Length (mm)	12.70
Heat Sink Height "A" (mm)	25.40
Heat Sink Mounting Direction	Vertical

MECHANICAL & PERFORMANCE

Drawing dimensions are shown in mm, (in)

Part Number	"X" Dim	"Y" Dim	"Z" Dim
532602B00000G	12.70 (0.500)	0.79 (0.031)	2.67 (0.105)



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